## ES2A THRU ES2G

SURFACE MOUNT SUPER FAST SWITCHING RECTIFIER

## TECHNICAL SPECIFICATION

## VOLTAGE: 50 TO 400V CURRENT: 2.0A

## FEATURES

- Ideal for surface mount pick and
place application
- Low profile package
- Built-in strain relief
- High surge capability
- Glass passivated chip
- Super fast recovery for high efficiency - High temperature soldering guaranteed:
$260^{\circ} \mathrm{C} / 10 \mathrm{sec} /$ at terminal


## MECHANICAL DATA

- Terminal: Plated leads solderable per MIL-STD 202E, method 208C
- Case: Molded with UL-94 Class V-O recognized flame retardant epoxy
- Polarity: Color band denotes cathode


MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS
(Single-phase, half-wave, 60 Hz , resistive or inductive load rating at $25^{\circ} \mathrm{C}$, unless otherwise stated, for capacitive load, derate current by 20\%)

| RATINGS | SYMBOL | ES2A | ES2B | ES2C | ES2D | ES2E | ES2G | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Repetitive Peak Reverse Voltage | $\mathrm{V}_{\text {RRM }}$ | 50 | 100 | 150 | 200 | 300 | 400 | V |
| Maximum RMS Voltage | $\mathrm{V}_{\text {RMS }}$ | 35 | 70 | 105 | 140 | 210 | 280 | V |
| Maximum DC Blocking Voltage | $V_{\text {DC }}$ | 50 | 100 | 150 | 200 | 300 | 400 | V |
| Maximum Average Forward Rectified Current $\left(T_{L}=110^{\circ} \mathrm{C}\right)$ | $\mathrm{I}_{\text {FAV) }}$ | 2.0 |  |  |  |  |  | A |
| Peak Forward Surge Current (8.3ms single half sine-wave superimposed on rated load) | $\mathrm{I}_{\text {FSM }}$ | 50 |  |  |  |  |  | A |
| Maximum Instantaneous Forward Voltage (at rated forward current) | $V_{F}$ | 0.95 |  |  | 1.25 |  |  | V |
| $\begin{array}{ll}\text { Maximum DC Reverse Current } & \mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C} \\ \text { (at rated DC blocking voltage) } & \mathrm{T}_{a}=100^{\circ} \mathrm{C}\end{array}$ | $\mathrm{I}_{\mathrm{R}}$ | $\begin{aligned} & 5.0 \\ & 350 \\ & \hline \end{aligned}$ |  |  |  |  |  | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ |
| Maximum Reverse Recovery Time (Note 1) | trr | 35 |  |  |  |  |  | nS |
| Typical Junction Capacitance (Note 2) | $\mathrm{C}_{\text {J }}$ | 25 |  |  |  |  |  | pF |
| Typical Thermal Resistance (Note 3) | $\mathrm{R}_{\theta}(\mathrm{ja})$ | 20 |  |  |  |  |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Storage and Operation Junction Temperature | $\mathrm{T}_{\text {STG }}, \mathrm{T}_{\mathrm{J}}$ | -50 to +150 |  |  |  |  |  | ${ }^{\circ} \mathrm{C}$ |

## Note:

1. Reverse recovery condition $I_{F}=0.5 \mathrm{~A}, \mathrm{I}_{\mathrm{R}}=1.0 \mathrm{~A}, \mathrm{lr}=0.25 \mathrm{~A}$.
2. Measured at 1.0 MHz and applied voltage of $4.0 \mathrm{~V}_{\mathrm{dc}}$
3.Thermal resistance from junction to terminal mounted on $5 \times 5 \mathrm{~mm}$ copper pad area
